IPC ASSOCIATION ELECTRONIC	© Copyright 2005.	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All right international and Pan-American copyright conventions.			nder both le	this document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowevel parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					ous Materia	ials and Mfg Information				
Supplier	r Information															
Company name* Company unique IE				nique ID	ID Unique ID .			ne ID Authority					Response Date*			
nsemi												2025-06-05				
Contact N	ame		Title - Conta	Title - Contact			Phone - Contact*					Email - Contact*				
Product-I	Env-Stewards		Product Enviro Compliance			1	NA					Product-Env-Stewards@onsemi.com				
uthorize	d Representative*	Title - Representative			P	Phone - Representative*				Email - Representative*						
Product-I	Env-Stewards	Product Enviro Compliance			1	NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number M		Ifr Item Number Mfr Item Name				Effective Date	Versio	Version Manufactur		ing Site	ite Weight*		UOM	Unit Type	
		MC14049BDG LOG CMOS INVE		ERTER HEX		2025-06-05	PH1			14	12.68	mg	Each			
<b>Ianufa</b>	cturing Process Inform	ation														
	Terminal Plating / Grid Array Material		Terminal Base Alloy J-STD-020 I		-STD-020 MSL I	Rating	Peak Process Body Temperatur		e Max Ti	me at Peak 7	Гетрегаtu	re Numb	er of Reflow Cyc	eles		
Matte Tin (Sn) - annealed		CU Alloy 1				260	C		30		seconds 3					
omments																
<u>vel 1 - m</u>	aximum time at peak tempera	ture during so	ldering is 10-3	30 seconds												
or more i	information regarding materia	al composition	please refer t	o page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a							
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of					
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the					

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.73	mg	Supplier	Silicon (Si)	7440-21-3		2.73	mg
Die Attach	4.85	mg		Epoxy resin	proprietary data		1.1155	mg
			Supplier	Silver (Ag)	7440-22-4		3.7345	mg
Lead Frame	75.92	mg	Supplier	Silver (Ag)	7440-22-4		0.7592	mg
			Supplier	Zinc (Zn)	7440-66-6		0.1518	mg
			Supplier	Iron (Fe)	7439-89-6		1.9739	mg
			Supplier	Copper (Cu)	7440-50-8		73.035	mg
Mold Compound-Black	55.11	mg		Epoxy resin	proprietary data		7.3296	mg
			Supplier	Carbon Black (C)	1333-86-4		0.1102	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		47.6702	mg
Plating	3.73	mg	Supplier	Tin (Sn)	7440-31-5		3.73	mg
Wire Bond	0.34	mg	Supplier	Palladium (Pd)	7440-05-3		0.0034	mg
			Supplier	Copper (Cu)	7440-50-8		0.3366	mg